



Product Change Notification

Change Notification #: 116995 - 00
Change Title: Select Intel® Optane™ SSD 900P Series and Intel® Optane™ SSD 905P Series SKUs, PCN 116995-00, Label, Label Update
Date of Publication: July 2, 2019

Key Characteristics of the Change:
Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	July 24, 2019
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Description of Change to the Customer:

The Intel® Optane™ SSD 900P Series and Intel® Optane™ SSD 905P Series SKUs listed in the Products Affected Table below will have the following change.

- Remove ISN Label assembly.




- The product labels will be updated to include an ISN# and barcode.
See example labels below.


Product Label - OPAL Version

Before

INTEL® OPTANE™ SSD XXXX **XXXGB**
Model: XXXXXXXXXXXXX **FW: XXXX**
SA: XXXXXX-XXX **PSID: XXXXXXXXXXXXXXXXXXXX**
XXXXXXXXXXXXXXXXXXXX




VDC AMPS
+12V X.XXA
+3.3V X.XA



Intel Corporation
 Attn: Corporate Quality
 2200 Mission College Blvd.
 Santa Clara, CA 95054-1549
 USA


Country of Origin: XXXXX
CAN ICES-3(X)/NMB-3(X)

WARRANTY VOID IF LABEL REMOVED OR DAMAGED




After

INTEL® OPTANE™ SSD XXXX **XXXGB**
Model: XXXXXXXXXXXXX **FW: XXXX**
SA: XXXXXX-XXX **PSID: XXXXXXXXXXXXXXXXXXXX**
XXXXXXXXXXXXXXXXXXXX



ISN: VSPPYWWDXXXXNNNFGN


VDC AMPS
+12V X.XXA
+3.3V X.XA



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 Attn: Corporate Quality
 2200 Mission College Blvd.
 Santa Clara, CA 95054-1549
 USA

Country of Origin: XXXXX
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WARRANTY VOID IF LABEL REMOVED OR DAMAGED



Before

INTEL® OPTANE™ SSD XXXX **XXXGB**
Model: XXXXXXXXXXXXXXXX **FW: XXXX**
SA: XXXXXX-XXX



VDC AMPS
+12V X.XXA
+3.3V X.XA



Intel Corporation
Attn: Corporate Quality
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Santa Clara, CA 95054-1549
USA

Country of Origin: XXXXX
CAN ICES-3(X)/NMB-3(X)

WARRANTY VOID IF LABEL REMOVED OR DAMAGED



After

INTEL® OPTANE™ SSD XXXX **XXXGB**
Model: XXXXXXXXXXXXXXXX **FW: XXXX**
SA: XXXXXX-XXX



ISN: VSPPYWWDXXXNNNFGN

VDC AMPS
+12V X.XXA
+3.3V X.XA



Intel Corporation
Attn: Corporate Quality
2200 Mission College Blvd.
Santa Clara, CA 95054-1549
USA

Country of Origin: XXXXX
CAN ICES-3(X)/NMB-3(X)

WARRANTY VOID IF LABEL REMOVED OR DAMAGED



Customer Impact of Change and Recommended Action:

There is no change to the Form, Fit, or Function of the product. The change is only to the labels used on the product.

Customers should be aware of the changes to the label and take appropriate actions to accommodate the changes and avoid impact to their process.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Name	Product Code	MM#	TA	SA
Intel® Optane™ SSD 900P Series (280GB, 1/2 Height PCIe x4, 3D XPoint™) Reseller Single Pack	SSDPED1D280GAX1	945760	H93319-304	H93321-304
Intel® Optane™ SSD 900P Series (480GB, 1/2 Height PCIe x4, 3D XPoint™) Reseller Single Pack	SSDPED1D480GAX1	945761	H93320-304	H93324-304
Intel® Optane™ SSD 905P Series (960GB, 1/2 Height PCIe x4, 3D XPoint™) Reseller Single Pack	SSDPED1D960GAX1	945762	J60240-303	J60246-303
Intel® Optane™ SSD 905P Series (1.5TB, 1/2 Height PCIe x4, 3D XPoint™) Reseller Single Pack	SSDPED1D015TAX1	945763	J60241-302	J60247-302
Intel® Optane™ SSD 900P Series (280GB, 1/2 Height PCIe 3.0 X4, 20nm 3D XPoint™)	SSDPED1D280GASX	962752	J78489-304	H93321-304
Intel® Optane™ SSD 900P Series (480GB, 1/2 Height PCIe 3.0 X4, 20nm 3D XPoint™)	SSDPED1D480GASX	962754	J78490-304	H93324-304

PCN Revision History:

Date of Revision:

July 2, 2019

Revision Number:

00

Reason:

Originally Published PCN



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116995 - 00

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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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